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Renesas Electronics website: http://www.renesas.com

April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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DATA SHEET

# MOS FIELD EFFECT TRANSISTOR NP109N04PUG

# SWITCHING N-CHANNEL POWER MOS FET

#### DESCRIPTION

The NP109N04PUG is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE		
NP109N04PUG-E1-AY <sup>Note</sup>		_			
NP109N04PUG-E2-AY <sup>Note</sup>	Pure Sn (Tin)	Tape 800 p/reel	TO-263 (MP-25ZP) typ. 1.5 g		

Note Pb-free (This product does not contain Pb in external electrode).

#### FEATURES

Super low on-state resistance

 $R_{DS(on)} = 2.3 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 55 \text{ A})$ 

• High current rating  $I_{D(DC)} = \pm 110 \text{ A}$ 

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vcs = 0 V)	Vdss	40	V	
Gate to Source Voltage ( $V_{DS} = 0 V$ )	Vgss	±20	V	
Drain Current (DC) (Tc = $25^{\circ}$ C)	D(DC)	±110	А	
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	±440	А	
Total Power Dissipation (Tc = 25°C)	Ρτ1	220	W	
Total Power Dissipation ( $T_A = 25^{\circ}C$ )	<b>P</b> T2	1.8	W	
Channel Temperature	Tch	175	°C	
Storage Temperature	Tstg	-55 to +175	°C	
Repetitive Avalanche Current Note2	IAR	60	А	
Repetitive Avalanche Energy Note2	Ear	360	mJ	
<b>Notes 1.</b> PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1%				
<b>2.</b> T <sub>ch</sub> $\leq$ 150°C, V <sub>DD</sub> = 20 V, R <sub>G</sub> = 25 $\Omega$ , V <sub>GS</sub> = 20 $\rightarrow$ 0 V				



(TO-263)

THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	0.68	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

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Document No. D18590EJ2V0DS00 (2nd edition) Date Published December 2007 NS Printed in Japan

The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

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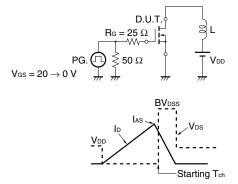
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
Gate to Source Threshold Voltage	VGS(th)	Vbs = Vgs, Ib = 250 μA	2.0	3.0	4.0	V
Forward Transfer Admittance	y <sub>fs</sub>	Vds = 10 V, Id = 55 A	31	63		S
Drain to Source On-state Resistance	RDS(on)	Vgs = 10 V, Id = 55 A		1.7	2.3	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 25 V,		10500	15750	pF
Output Capacitance	Coss	V <sub>G</sub> s = 0 V,		980	1470	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		630	1140	pF
Turn-on Delay Time	td(on)	$V_{DD} = 20 V, I_D = 55 A,$		47	103	ns
Rise Time	tr	Vgs = 10 V,		35	70	ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 0 Ω		90	180	ns
Fall Time	tr			35	70	ns
Total Gate Charge	QG	$V_{DD} = 32 V,$		180	270	nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>G</sub> s = 10 V,		44		nC
Gate to Drain Charge	Qgd	ID = 110 A		64		nC
Body Diode Forward Voltage	VF(S-D)	IF = 110 A, VGs = 0 V		0.9	1.4	V
Reverse Recovery Time	trr	IF = 110 A, VGs = 0 V,		56		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		80		nC

# ELECTRICAL CHARACTERISTICS (TA = 25°C)

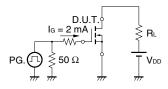
#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

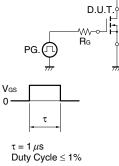
#### **TEST CIRCUIT 2 SWITCHING TIME**

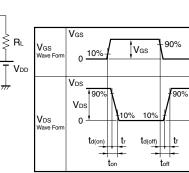
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#### TEST CIRCUIT 3 GATE CHARGE

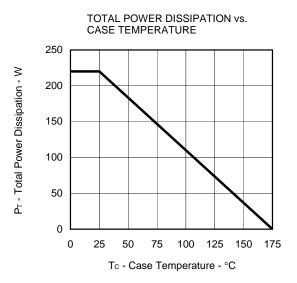




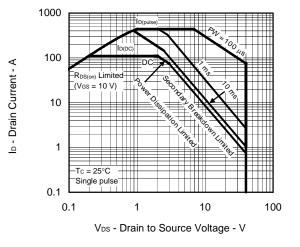


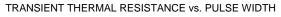
#### DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA 120 dT - Percentage of Rated Power - % 100 80 60 40 20 0 0 25 50 75 100 125 150 175 Tc - Case Temperature - °C

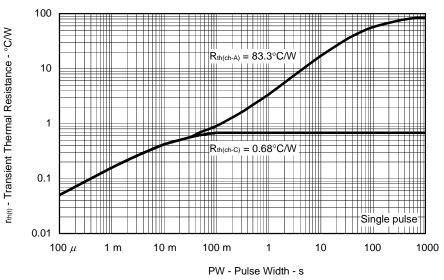
TYPICAL CHARACTERISTICS (TA = 25°C)



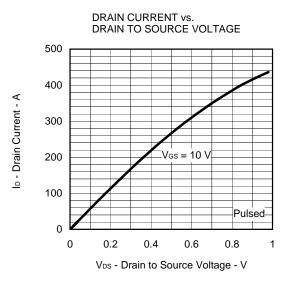
FORWARD BIAS SAFE OPERATING AREA



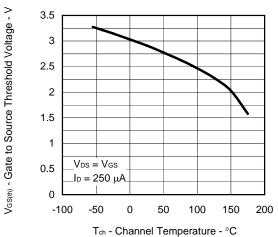




Data Sheet D18590EJ2V0DS

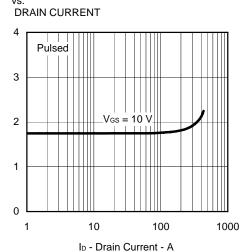


GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

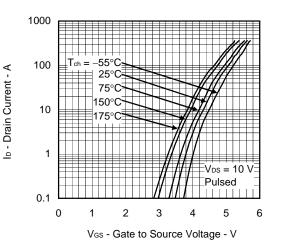


DRAIN TO SOURCE ON-STATE RESISTANCE vs.

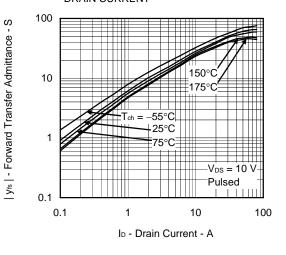
 $R^{\text{DS}(\text{cn})}$  - Drain to Source On-state Resistance -  $m\Omega$ 

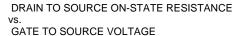


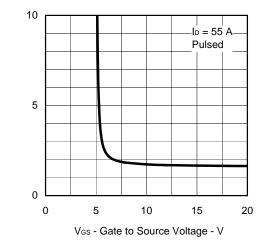
FORWARD TRANSFER CHARACTERISTICS



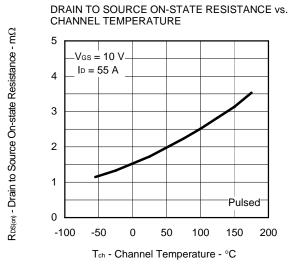
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



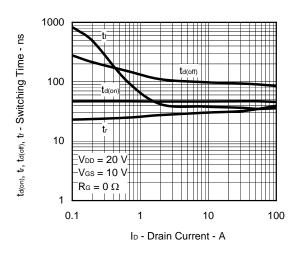




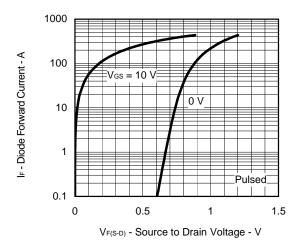
 $R_{DS(or)}$  - Drain to Source On-state Resistance -  $m\Omega$ 



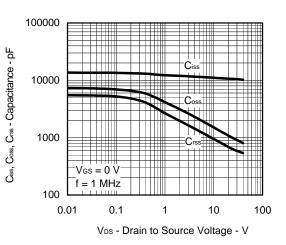




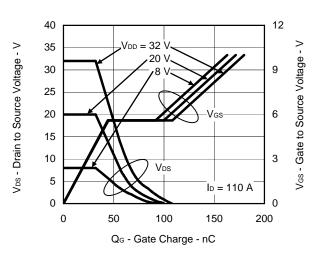
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



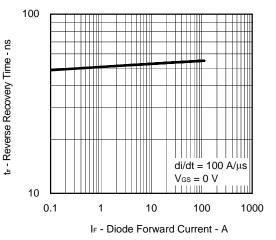




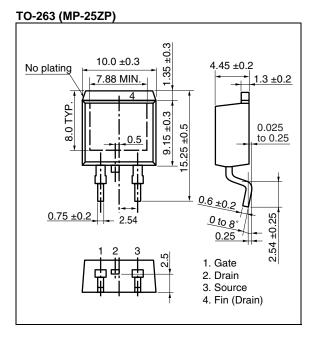
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



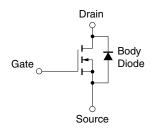
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



### PACKAGE DRAWING (Unit: mm)



#### EQUIVALENT CIRCUIT



**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

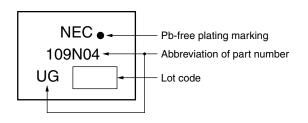
# NEC

# TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



# MARKING INFORMATION



# **RECOMMENDED SOLDERING CONDITIONS**

The NP109N04PUG should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below	IR60-00-3
	Time at maximum temperature: 10 seconds or less	
	Time of temperature higher than 220°C: 60 seconds or less	
	Preheating time at 160 to 180°C: 60 to 120 seconds	
	Maximum number of reflow processes: 3 times	
	Maximum chlorine content of rosin flux (percentage mass): 0.2% or less	
Partial heating	Maximum temperature (Pin temperature): 350°C or below	P350
	Time (per side of the device): 3 seconds or less	
	Maximum chlorine content of rosin flux: 0.2% (wt.) or less	

Caution Do not use different soldering methods together (except for partial heating).

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